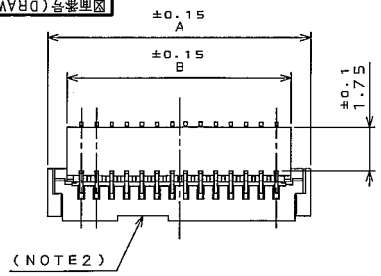
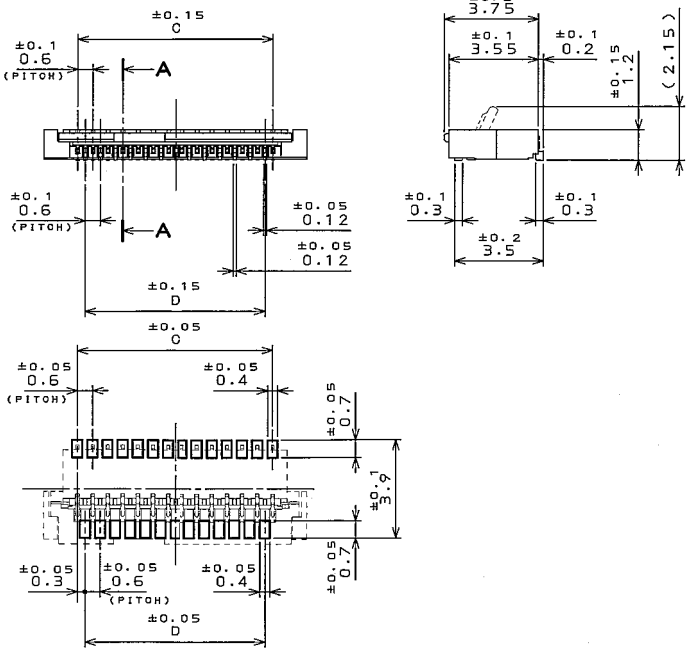
版数 REV.	年月日 DATE	DCN NO.	変更内容 DESCRIPTION	製図 DR.	担当 CHK.	査閲 APPD.	承認 APPD.
5	20.Jan.2006	059075	REDRAWN, ADDED ITEM		N.IKENAGA	—	K.Ibaraki

図面番号(DRAWING NO.) SJ102078

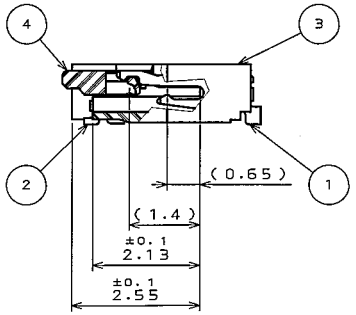




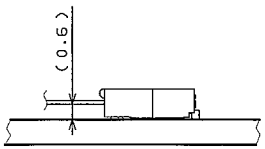
APPLICABLE P.C.B. DIMENSION(REF.)
適合基板寸法(参考)

TABLE 1

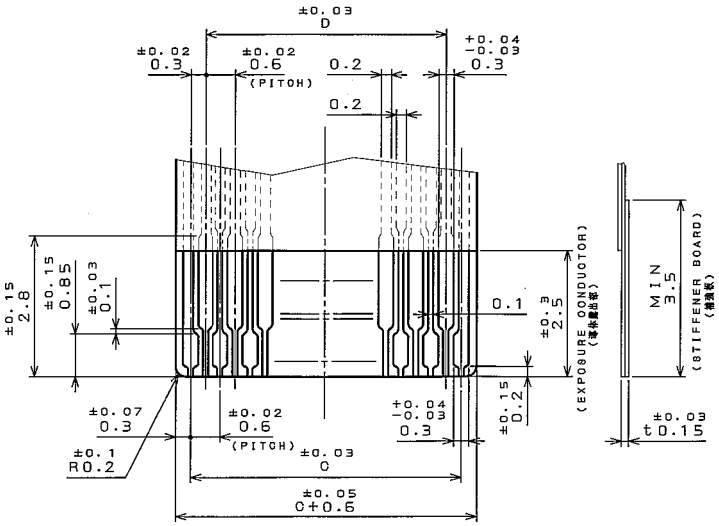
NO. OF CONTACT	A	B	C	D
15	6.9	5.35	4.2	3.6
17	7.5	5.95	4.8	4.2
21	8.7	7.15	6.0	5.4
25	9.9	8.35	7.2	6.6
27	10.5	8.95	7.8	7.2
29	11.1	9.55	8.4	7.8
33	12.3	10.75	9.6	9.0
39	14.1	12.55	11.4	10.8
45	15.9	14.35	13.2	12.6
51	17.7	16.15	15.0	14.4
⚠6 53	18.3	16.75	15.6	15.0
57	19.5	17.95	16.8	16.2
59	20.1	18.55	17.4	16.8



SECT. A-A
(SCALE 10:1)



MATED CONDITION(REF.)
嵌合状態図(参考)



APPLICABLE F.P.C DIMENSION(REF.)
適合FPC寸法(参考)
(THICKNESS:0.15±0.03)

NOTE1.POLYIMIDE SHOULD BE USED AS A STIFFENER BOARD AND THERMOSETTING ADHESIVE SHOULD BE USED.
BARE TRACES SHOULD BE GIVEN GOLD PLATING.
NOTE2.THE ACTUATOR HAS A HOLLOW SOMEWHERE AS SHOWN.

注1.適合FPCの補強板はポリイミドを使用し、接着剤は熱硬化性を使用すること。
又、仕上げは金メッキのこと。
注2.アクチュエータのどこかに図示のような凹形状が付いています。

NO.	DESCRIPTION	QTY.	MATERIAL	FINISH	REMARKS
4	ACTUATOR	1	GLASS FILLED Ny		COLOR:BLACK UL94V-0
3	BASE INSULATOR	1	GLASS FILLED LCP		COLOR:BEIGE UL94V-0
2	CONTACT 2	n−1 / 2	COPPER ALLOY	SELECTIVE GOLD PLATING	
1	CONTACT 1	n+1 / 2	COPPER ALLOY	SELECTIVE GOLD PLATING	

符号 名称 個数 材料 仕上 備考

仕様書(SPECIFICATION)
JACS-10226
JAHL-10226

第1版(ORIGINAL DATE) 7.Dec.2004

尺度(SCALE) 5:1

シリーズ(SERIES) FB6

名称(TITLE) FB6S***JA1

一般公差(GENERAL TOLERANCE)

寸法(DIMENSION)	角度(ANGLES)
. ±0.8	X° ±
.X ±0.4	X°X'±
.XX ±0.1	
.XXX±	

製図 DR.	
担当 CHK.	N.IKENAGA
査閲 APPD.	
承認 APPD.	S.KASHIWAGI

質量(MASS)

日本航空電子工業株式会社
JAPAN AVIATION ELECTRONICS INDUSTRY, LTD.

図面番号(DRAWING NO.) SJ102078

版数(REV.) 5

SIZE A3

DOF-0-212F(05.08)

0 10 20 30 40 50 60 70 80 90 100

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